# Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
Atsushi Sato	11/17/2006
Hideki Sakai	11/17/2006
Mamoru Hatakeyama	11/24/2006
Takaaki Nakagawa	11/20/2006

## **RECEIVING PARTY DATA**

Name:	Sony Corporation
Street Address:	1-7-1 Konan, Minato-Ku
City:	Tokyo
State/Country:	JAPAN

### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11458920

## **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	112857-895
NAME OF SUBMITTER:	Thomas C. Basso

Total Attachments: 5

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PATENT REEL: 023112 FRAME: 0197 11458920

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> PATENT REEL: 023112 FRAME: 0198

#### ASSIGNMENT

WHEREAS, the undersigned, to wit: Atsushi Sato, Hideki Sakai, Mamoru Hatakeyama and Takaaki Nakagawa (hereinafter "ASSIGNORS"), are the lawful owners of an invention entitled: POROUS ELECTROCONDUCTIVE MATERIAL AND PROCESS FOR PRODUCTION THEREOF; ELECTRODE AND PROCESS FOR PRODUCTION THEREOF; FUEL CALL AND PROCESS FOR PRODUCTION THEREOF; AND ELECTRONIC INSTRUMENT, MOBILE MACHINE, ELECTRIC POWER GENERATING SYSTEM, COGENERATION SYSTEM, AND ELECTRODE REACTION-BASED APPARATUS, for which a patent application of the United States was filed on July 16, 2006 in the United States Patent and Trademark Office having Application Serial No. 11/458,920;

AND WHEREAS, <u>Sony Corporation</u> (hereinafter "ASSIGNEE"), a corporation duly organized and existing under the laws of <u>Japan</u> and having its principal office and place of business at <u>7-35</u>, <u>Kitashinagawa 6-chome</u>, <u>Shinagawa-ku</u>, <u>Tokyo</u>, <u>Japan</u>, desires to acquire the entire right, title, and interest therein;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, said ASSIGNORS do hereby sell, assign, and transfer, and hereby set over unto ASSIGNEE, its successors, assigns and legal representatives, the full and exclusive right, title and interest to said invention in the United States of America and all foreign countries, including, without limitation, said invention as described in the aforesaid application, to be held and enjoyed by said ASSIGNEE, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by said ASSIGNORS had this assignment and sale not been made, including, without limitation, all rights to the aforesaid application and to any United States Letters Patent therefor, when issued together with all improvements thereon and betterments thereof, all related applications including, but not limited to, divisions, continuations, continuations-in-part, reissues and reexaminations thereof and substitutions of or for said application, and all foreign rights including the right to make application for Letters Patent for said inventions in any and all foreign countries and the right to claim priority as to the filing date under the International Convention on the basis for the aforesaid application for United States Letters Patent; and ASSIGNORS hereby authorize and request the Commissioner of Patents to issue all Letters Patent issuing therefrom to ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives.

ASSIGNORS hereby agree to execute any papers, provide any information and testify in any interference or litigation at the request of ASSIGNEE, its successors, assigns and legal representatives, when deemed essential to ASSIGNEE's, its successors', assigns' and legal representatives' full enjoyment, protection, enforcement and title in and to such invention and rights hereby transferred.

ASSIGNORS furthermore agree upon request of said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, to execute any and all papers desired by said ASSIGNEE, its successors, assigns and legal representatives, for the filing and granting of foreign applications and the perfecting of title thereto in said ASSIGNEE, its successors, assigns and legal representatives.

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Si	gna	ture

Address:

c/o Sony Corporation

7-35, Kitashinagawa 6-chome Shinagawa-ku, Tokyo, Japan

Date Signed

November 17, 2006

November 17, 2006

Before me personally appeared the person whose name is subscribed to the foregoing instrument, and executed the foregoing instrument in my presence for the purpose contained therein, by signing his/her name hereto.

Signature

**Date Signed** 

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Signature	
Hid	elei Saleai
Name: Hi	
Address:	c/o Sony Corporation 7-35, Kitashinagawa 6-chome

Shinagawa-ku, Tokyo, Japan

Date Signed

11/17/2006

November 17, 2006

Before me personally appeared the person whose name is subscribed to the foregoing instrument, and executed the foregoing instrument in my presence for the purpose contained therein, by signing his/her name hereto.

<u>Signature</u>

Date Signed

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Signature

Mamon Satakeyana

Date Signed

November 29, 2006

1: November 24, 2006

Address:

c/o Sony Corporation

7-35, Kitashinagawa 6-chome Shinagawa-ku, Tokyo, Japan

Before me personally appeared the person whose name is subscribed to the foregoing instrument, and executed the foregoing instrument in my presence for the purpose contained therein, by signing his/her name hereto.

Signature

Date Signed

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Date Signed

Naember 20, 2006

Takaaki Nakagawa

Address:

c/o Sony Corporation

7-35, Kitashinagawa 6-chome Shinagawa-ku, Tokyo, Japan

Before me personally appeared the person whose name is subscribed to the foregoing instrument, and executed the foregoing instrument in my presence for the purpose contained therein, by signing his/her name hereto.

Signature

Date Signed

November 20, 2006

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